

A

B

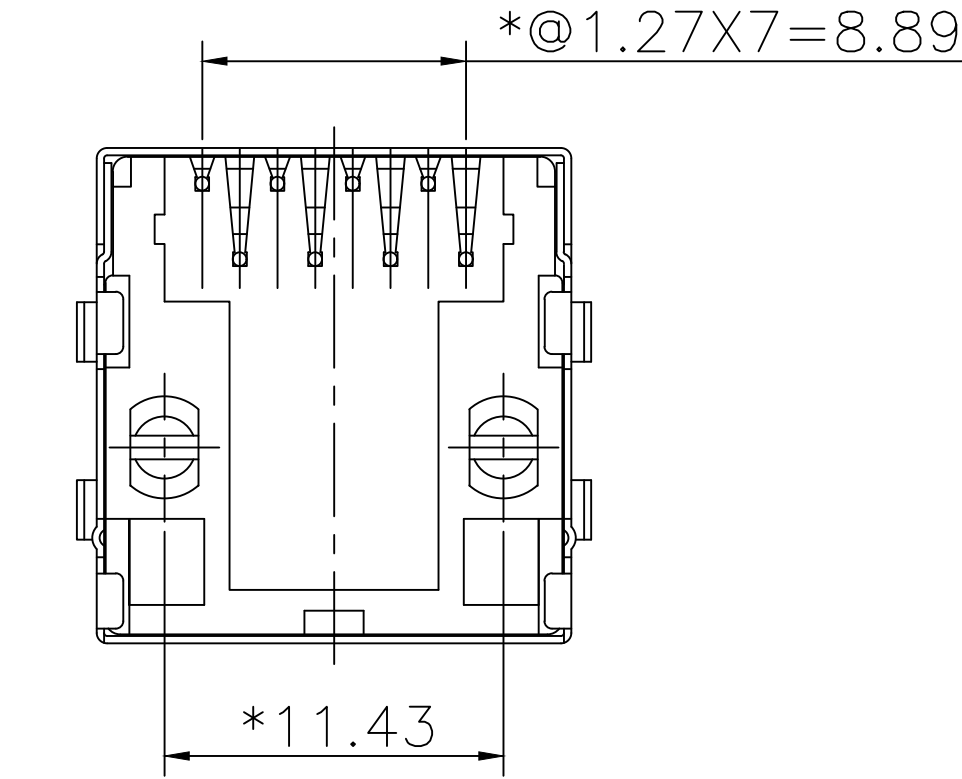
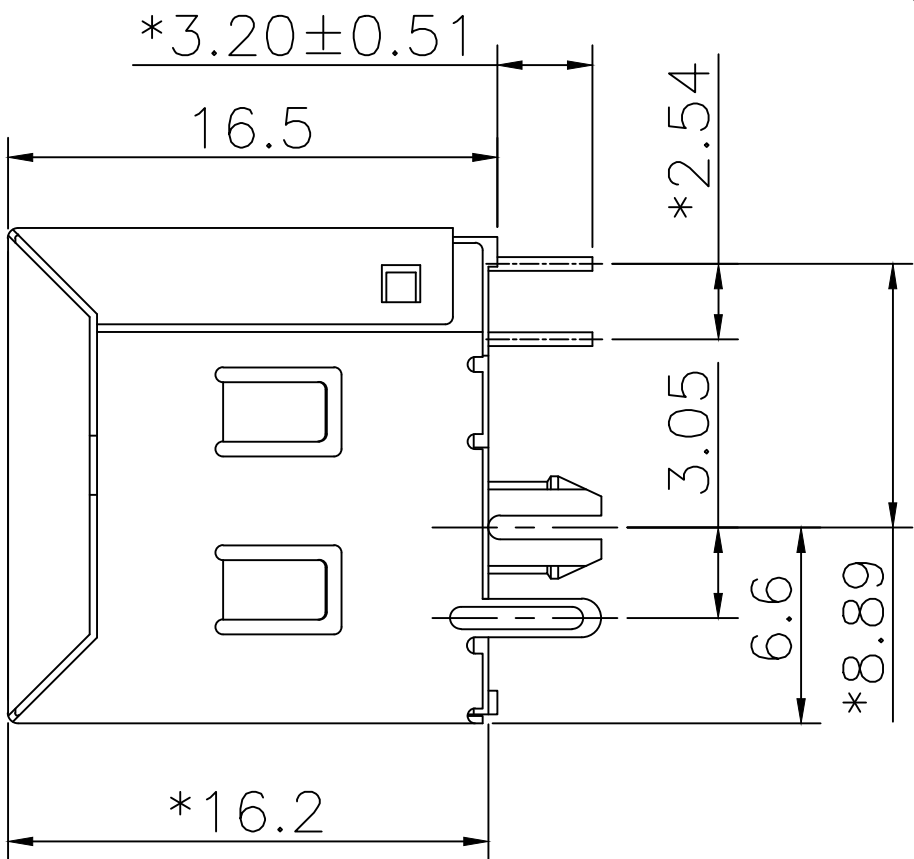
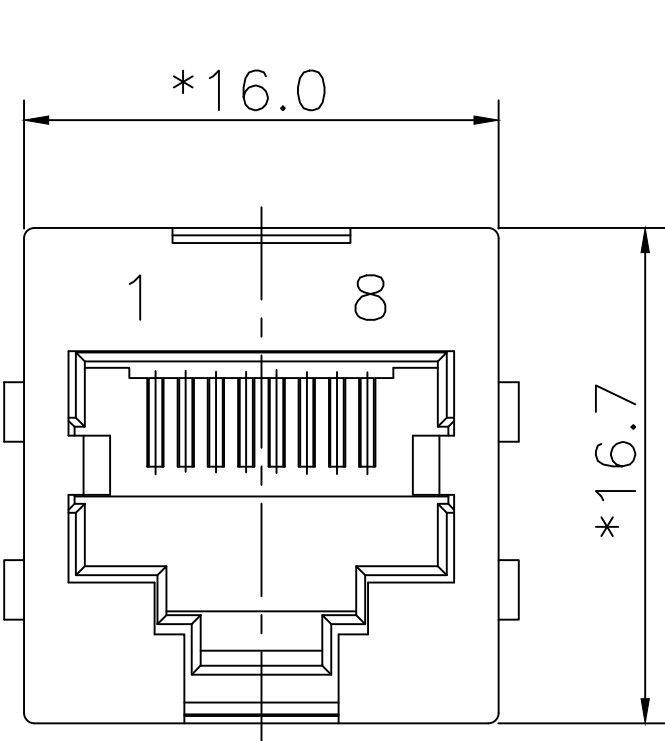
C

D

A

B

C



NOTES:

ELECTRICAL:

1. VOLTAGE RATING : 125 VAC RMS.
2. CURRENT RATING : 1.5 AMP.
3. CONTACT RESISTANCE : 45 MILLIOHMS MAX.
4. INSULATION RESISTANCE: 1000 MEGOHMS MIN @ 500 VDC.
5. DIELECTRIC STRENGTH : 1000 VDC RMS 60Hz, 1MIN.

MECHANICAL:

1. HOUSING MATERIAL : PBT UL94V-0.
2. CONTACT MATERIAL : PHOSPHOR BRONZE ϕ 0.46mm.
3. PLATING : GOLD PLATING OVER NICKEL.
4. OPERATING LIFE : 750 CYCLES MIN.
5. PCB RETENTION PRE-SOLDER : 1 LB MIN.
6. PCB RETENTION POST-SOLDER: 10 LBS MIN.

ENVIRONMENTAL:

1. STORAGE : -40°C TO +85°C.
2. OPERATION: -40°C TO +85°C.
3. WAVE SOLDERING TEMPERRATURE: 230~245°C(3~5 SECONDS).
4. RoHS COMPLIANT.

MATES WITH MODULAR PLUG CONFORMING TO

FCC PART 68, SUBPART F.

CUL FILE NO. E345295

PART NUMBER: EL2288-X3X0X2X

0-W/O LOGO

SHIELD PLATING:

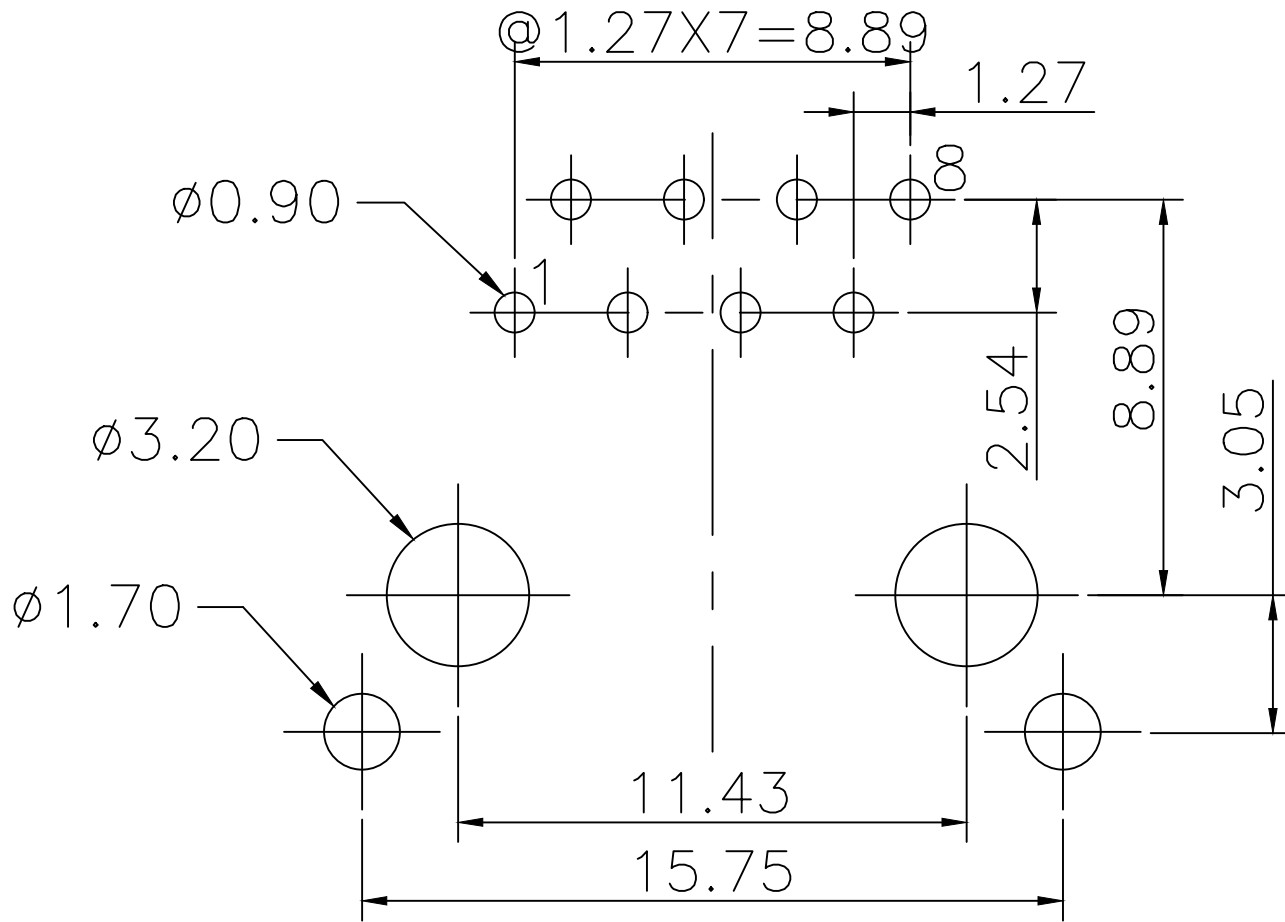
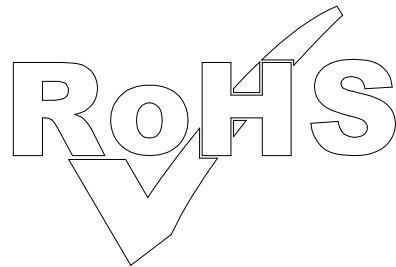
- 1-TIN PLATING,W/ SIDE TABS
- 2-NICKEL PLATING,W/ SIDE TABS
- S-TIN PLATING,W/O SIDE TABS
- T-NICKEL PLATING,W/O SIDE TABS

GOLD PLATING:

- 1-3u", 2-6u"
- 3-15u", 4-30u"
- 5-50u", F-GOLD FLASH
- D-1.5u" H-1u"

Color Of Housing:

- 0-PBT BLACK
- Z-PBT YELLOW 114C
- B-NYLON BLACK



PC Board Layout Component Side Shown

單位: mm		DFTO:	DATE: 2019.10.01	ELIAX CORPORATION. TITLE: RJ45 TOP ENTRY PCB MODULAR JACK(DIP TYPE)		
長度公差	角度公差	CHKD: Eason	DATE: 2019.10.01			
.0±0.25	0°±5°	APPVL: W.B.Huang	DATE: 2019.10.01			
.00±0.15		脫模角:	顏色:			
.000±0.10			MATERIAL: 材 質	DWG NO. EL2288-03T002F SIZE A4 REV A		
			TREAT: 處 理			
			QTY: 數 量			
			SCALE: 1:1 比 例	DRAWING NO: EL2288-X3X0X2X_A PART NO: 零件編號 1 of 1		